



Docket No.
90065.001020/17732.8011.00

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

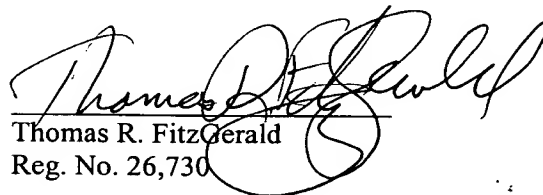
Applicant	: Martin E. Kordes, et al.) Examiner:
Serial No.	: 09/682,151) Chris C. Chu
Filed	: 27 July 2001) Art Unit:
For	: CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS) 2815

Assistant Commissioner for Patents
Washington, DC 20231

TRANSMITTAL LETTER

In response to the office action mailed January 2, 2003, Applicants hereby submit the attached supplemental Declaration in connection with the above-referenced patent application.

Respectfully submitted,


Thomas R. FitzGerald
Reg. No. 26,730

Thomas R. FitzGerald, Esquire
16 E. Main Street, Suite 210
Rochester, New York 14614
Telephone: (585) 454-2250
Fax: (585) 454-6364

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CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)

Applicant(s): Martin E. Kordes, et al.

Docket No.

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Serial No.
09/682,151

Filing Date
July 27, 2001

Examiner
Chris C. Chu

Group Art Unit
2815

Invention: CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS



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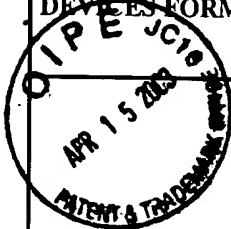
Examiner

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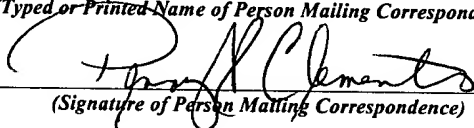


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